MC14018B

Presettable Divide-By-N Counter

The MC14018B contains five Johnson counter stages which are asynchronously presettable and resettable. The counters are synchronous, and increment on the positive going edge of the clock.

Presetting is accomplished by a logic 1 on the preset enable input. Data on the Jam inputs will then be transferred to their respective $\overline{Q}$ outputs (inverted). A logic 1 on the reset input will cause all $\overline{Q}$ outputs to go to a logic 1 state.

Division by any number from 2 to 10 can be accomplished by connecting appropriate $\overline{Q}$ outputs to the data input, as shown in the Function Selection table. Anti−lock gating is included in the MC14018B to assure proper counting sequence.

Features

- Fully Static Operation
- Schmitt Trigger on Clock Input
- Capable of Driving Two Low−Power TTL Loads or One Low−Power Schottky TTL Load Over the Rated Temperature Range
- Pin−for−Pin Replacement for CD4018B
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
- This Device is Pb−Free and is RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	−0.5 to +18.0	V
V_{in}, V_{out}	Input or Output Voltage Range (DC or Transient)	−0.5 to V_{DD} + 0.5	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
P_D	Power Dissipation, per Package (Note 1)	500	mW
T_A	Ambient Temperature Range	−55 to +125	°C
T_{stg}	Storage Temperature Range	−65 to +150	°C
T_L	Lead Temperature (8−Second Soldering)	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: −7.0 mW/°C From 65°C To 125°C
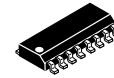
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high−impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \le (V_{in}$ or $V_{out}) \le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.
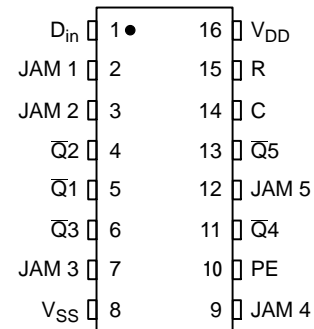
SOIC−16
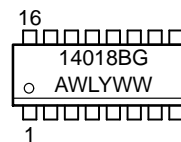**D SUFFIX**
CASE 751B

PIN ASSIGNMENT

D_{in}	1 ●	16	V_{DD}
JAM 1	2	15	R
JAM 2	3	14	C
$\overline{Q}2$	4	13	$\overline{Q}5$
$\overline{Q}1$	5	12	JAM 5
$\overline{Q}3$	6	11	$\overline{Q}4$
JAM 3	7	10	PE
V_{SS}	8	9	JAM 4

MARKING DIAGRAM

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14018BG
AWLYWW

1

A	= Assembly Location
WL, L	= Wafer Lot
YY, Y	= Year
WW, W	= Work Week
G	= Pb−Free Indicator

FUNCTIONAL TRUTH TABLE

Clock	Reset	Preset Enable	Jam Input	$\overline{Q}n$
⊐	0	0	X	$\overline{Q}n$
⌐	0	0	X	$\overline{D}_n$*
X	0	1	0	1
X	0	1	1	0
X	1	X	X	1

*D_n is the Data input for that stage. Stage 1 has Data brought out to Pin 1.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic		Symbol	V_{DD} Vdc	−55°C		25°C			125°C		Unit
				Min	Max	Min	Typ (Note 2)	Max	Min	Max	
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0		V_{OL}	5.0	–	0.05	–	0	0.05	–	0.05	Vdc
			10	–	0.05	–	0	0.05	–	0.05	
			15	–	0.05	–	0	0.05	–	0.05	
$V_{in} = 0$ or V_{DD} "1" Level		V_{OH}	5.0	4.95	–	4.95	5.0	–	4.95	–	Vdc
			10	9.95	–	9.95	10	–	9.95	–	
			15	14.95	–	14.95	15	–	14.95	–	
Input Voltage "0" Level (V_O = 4.5 or 0.5 Vdc) (V_O = 9.0 or 1.0 Vdc) (V_O = 13.5 or 1.5 Vdc)		V_{IL}	5.0	–	1.5	–	2.25	1.5	–	1.5	Vdc
			10	–	3.0	–	4.50	3.0	–	3.0	
			15	–	4.0	–	6.75	4.0	–	4.0	
(V_O = 0.5 or 4.5 Vdc) "1" Level (V_O = 1.0 or 9.0 Vdc) (V_O = 1.5 or 13.5 Vdc)		V_{IH}	5.0	3.5	–	3.5	2.75	–	3.5	–	Vdc
			10	7.0	–	7.0	5.50	–	7.0	–	
			15	11	–	11	8.25	–	11	–	
Output Drive Current (V_{OH} = 2.5 Vdc) Source (V_{OH} = 4.6 Vdc) (V_{OH} = 9.5 Vdc) (V_{OH} = 13.5 Vdc)		I_{OH}	5.0	−3.0	–	−2.4	−4.2	–	−1.7	–	mAdc
			5.0	−0.64	–	−0.51	−0.88	–	−0.36	–	
			10	−1.6	–	−1.3	−2.25	–	−0.9	–	
			15	−4.2	–	−3.4	−8.8	–	−2.4	–	
(V_{OL} = 0.4 Vdc) Sink (V_{OL} = 0.5 Vdc) (V_{OL} = 1.5 Vdc)		I_{OL}	5.0	0.64	–	0.51	0.88	–	0.36	–	mAdc
			10	1.6	–	1.3	2.25	–	0.9	–	
			15	4.2	–	3.4	8.8	–	2.4	–	
Input Current		I_{in}	15	–	±0.1	–	±0.00001	±0.1	–	±1.0	µAdc
Input Capacitance (V_{in} = 0)		C_{in}	–	–	–	–	5.0	7.5	–	–	pF
Quiescent Current (Per Package)		I_{DD}	5.0	–	5.0	–	0.005	5.0	–	150	µAdc
			10	–	10	–	0.010	10	–	300	
			15	–	20	–	0.015	20	–	600	
Total Supply Current (Notes 3 & 4) (Dynamic plus Quiescent, Per Package) (C_L = 50 pF on all outputs, all buffers switching)		I_T	5.0	I_T = (0.3 µA/kHz) f + I_{DD}							µAdc
			10	I_T = (0.7 µA/kHz) f + I_{DD}							
			15	I_T = (1.0 µA/kHz) f + I_{DD}							

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
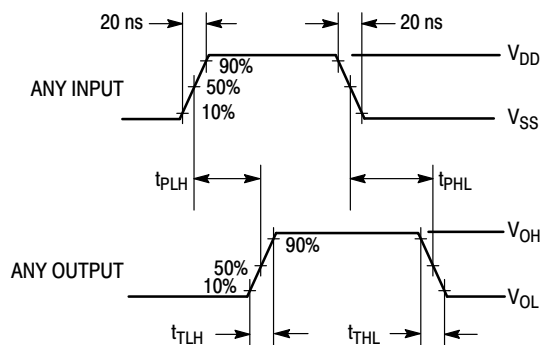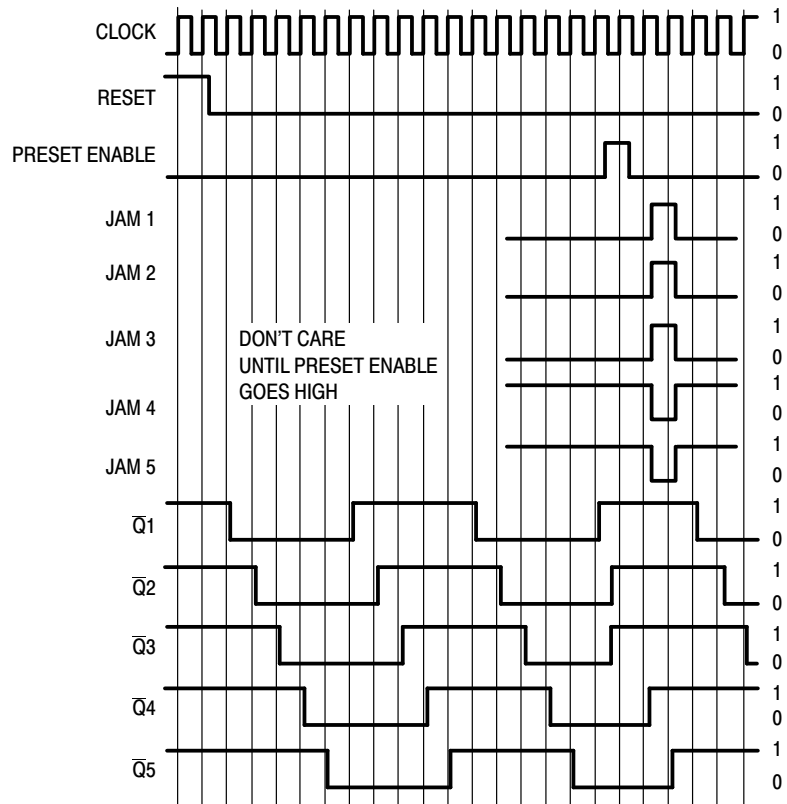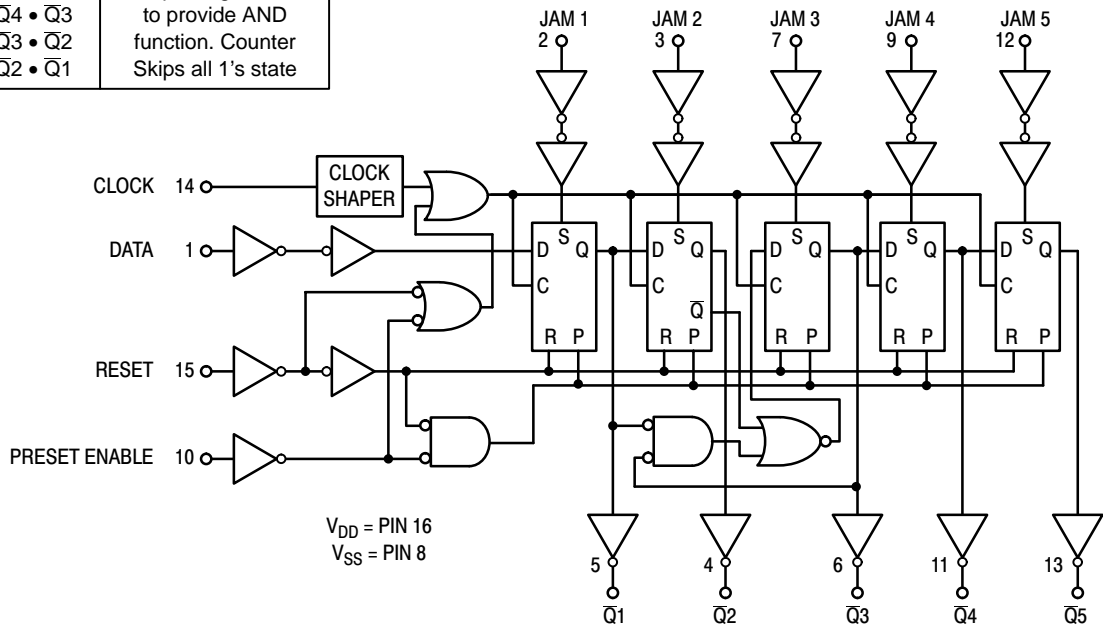3. The formulas given are for the typical characteristics only at 25°C.
4. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where: I_T is in µA (per package), C_L in pF, V = (V_{DD} − V_{SS}) in volts, f in kHz is input frequency, and k = 0.001.

ORDERING INFORMATION

Device	Package	Shipping[†]
MC14018BDG	SOIC−16 (Pb−Free)	48 Units / Rail
NLV14018BDG*	SOIC−16 (Pb−Free)	48 Units / Rail
MC14018BDR2G	SOIC−16 (Pb−Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable.

MC14018B

SWITCHING CHARACTERISTICS (Note 5) (C_L = 50 pF, T_A = 25°C)

Characteristic	Symbol	V_{DD} Vdc	All Types Min	All Types Typ (Note 6)	All Types Max	Unit
Output Rise and Fall Time t_{TLH}, t_{THL} = (1.35 ns/pF) C_L + 32 ns t_{TLH}, t_{THL} = (0.6 ns/pF) C_L + 20 ns t_{TLH}, t_{THL} = (0.4 ns/pF) C_L + 20 ns	t_{TLH}, t_{THL}	5.0 10 15	– – –	100 50 40	200 100 80	ns
Propagation Delay Time Clock to $\overline{Q}$ t_{PLH}, t_{PHL} = (0.90 ns/pF) C_L + 265 ns t_{PLH}, t_{PHL} = (0.36 ns/pF) C_L + 102 ns t_{PLH}, t_{PHL} = (0.26 ns/pF) C_L + 72 ns	t_{PLH}, t_{PHL}	5.0 10 15	– – –	310 120 85	620 240 170	ns
Reset to $\overline{Q}$ t_{PLH} = (0.90 ns/pF) C_L + 325 ns t_{PLH} = (0.36 ns/pF) C_L + 132 ns t_{PLH} = (0.26 ns/pF) C_L + 81 ns		5.0 10 15	– – –	370 150 100	740 300 200	ns
Preset Enable to $\overline{Q}$ t_{PLH}, t_{PHL} = (0.90 ns/pF) C_L + 325 ns t_{PLH}, t_{PHL} = (0.36 ns/pF) C_L + 132 ns t_{PLH}, t_{PHL} = (0.26 ns/pF) C_L + 81 ns		5.0 10 15	– – –	370 150 100	740 300 200	ns
Setup Time Data (Pin 1) to Clock	t_{su}	5.0 10 15	200 100 80	0 0 0	– – –	ns
Jam Inputs to Preset Enable		5.0 10 15	200 100 80	0 0 0	– – –	ns
Data (Jam Inputs)–to–Preset Enable Hold Time	t_h	5.0 10 15	540 500 480	270 250 240	– – –	ns
Clock Pulse Width	t_{WH}	5.0 10 15	400 200 160	200 100 80	– – –	ns
Reset or Preset Enable Pulse Width	t_{WH}	5.0 10 15	290 130 110	145 65 55	– – –	ns
Clock Rise and Fall Time	t_{TLH}, t_{THL}	5.0 10 15	No Limit			ns
Clock Pulse Frequency	f_{cl}	5.0 10 15	– – –	2.5 6.5 8.0	1.25 3.25 4.0	MHz

5. The formulas given are for the typical characteristics only at 25°C.
6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

Figure 1. Switching Time Waveforms

MC14018B

TIMING DIAGRAM
($\overline{Q}5$ Connected to Data Input)

CLOCK

RESET

PRESET ENABLE

JAM 1

JAM 2

JAM 3

DON'T CARE
UNTIL PRESET ENABLE
GOES HIGH

JAM 4

JAM 5

$\overline{Q}1$

$\overline{Q}2$

$\overline{Q}3$

$\overline{Q}4$

$\overline{Q}5$

FUNCTION SELECTION

Counter Mode	Connect Data Input (Pin 1) to:	Comments
Divide by 10	$\overline{Q}5$	
Divide by 8	$\overline{Q}4$	
Divide by 6	$\overline{Q}3$	No external components needed.
Divide by 4	$\overline{Q}2$	
Divide by 2	$\overline{Q}1$	
Divide by 9	$\overline{Q}5 \bullet \overline{Q}4$	Gate package needed to provide AND function. Counter Skips all 1's state
Divide by 7	$\overline{Q}4 \bullet \overline{Q}3$	
Divide by 5	$\overline{Q}3 \bullet \overline{Q}2$	
Divide by 3	$\overline{Q}2 \bullet \overline{Q}1$	

LOGIC DIAGRAM

JAM 1
2

JAM 2
3

JAM 3
7

JAM 4
9

JAM 5
12

CLOCK 14

CLOCK SHAPER

DATA 1

RESET 15

PRESET ENABLE 10

V_{DD} = PIN 16
V_{SS} = PIN 8

D S Q
C
$\overline{Q}$
R P

5
$\overline{Q}1$

4
$\overline{Q}2$

6
$\overline{Q}3$

11
$\overline{Q}4$

13
$\overline{Q}5$
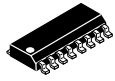
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ISSUE K

SCALE 1:1

DATE 29 DEC 2006
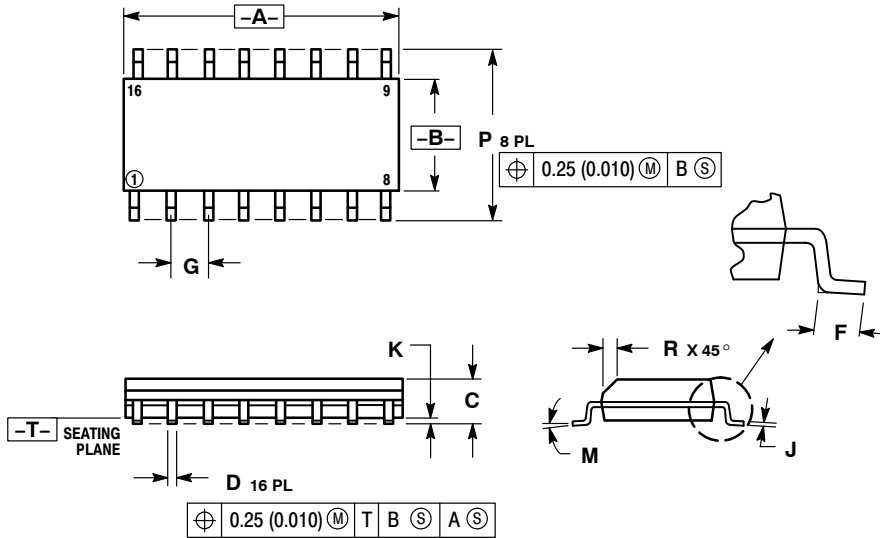
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

−A−

16   9

−B−   P 8 PL

⊕ | 0.25 (0.010) Ⓜ | B Ⓢ

①   8

G

K

C

−T− SEATING PLANE

R X 45°   F

M   J

D 16 PL

⊕ | 0.25 (0.010) Ⓜ | T | B Ⓢ | A Ⓢ

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

STYLE 1:
PIN 1. COLLECTOR
2. BASE
3. EMITTER
4. NO CONNECTION
5. EMITTER
6. BASE
7. COLLECTOR
8. COLLECTOR
9. BASE
10. EMITTER
11. NO CONNECTION
12. EMITTER
13. BASE
14. COLLECTOR
15. EMITTER
16. COLLECTOR

STYLE 2:
PIN 1. CATHODE
2. ANODE
3. NO CONNECTION
4. CATHODE
5. CATHODE
6. NO CONNECTION
7. ANODE
8. CATHODE
9. CATHODE
10. ANODE
11. NO CONNECTION
12. CATHODE
13. CATHODE
14. NO CONNECTION
15. ANODE
16. CATHODE

STYLE 3:
PIN 1. COLLECTOR, DYE #1
2. BASE, #1
3. EMITTER, #1
4. COLLECTOR, #1
5. COLLECTOR, #2
6. BASE, #2
7. EMITTER, #2
8. COLLECTOR, #2
9. COLLECTOR, #3
10. BASE, #3
11. EMITTER, #3
12. COLLECTOR, #3
13. COLLECTOR, #4
14. BASE, #4
15. EMITTER, #4
16. COLLECTOR, #4

STYLE 4:
PIN 1. COLLECTOR, DYE #1
2. COLLECTOR, #1
3. COLLECTOR, #2
4. COLLECTOR, #2
5. COLLECTOR, #3
6. COLLECTOR, #3
7. COLLECTOR, #4
8. COLLECTOR, #4
9. BASE, #4
10. EMITTER, #4
11. BASE, #3
12. EMITTER, #3
13. BASE, #2
14. EMITTER, #2
15. BASE, #1
16. EMITTER, #1

STYLE 5:
PIN 1. DRAIN, DYE #1
2. DRAIN, #1
3. DRAIN, #2
4. DRAIN, #2
5. DRAIN, #3
6. DRAIN, #3
7. DRAIN, #4
8. DRAIN, #4
9. GATE, #4
10. SOURCE, #4
11. GATE, #3
12. SOURCE, #3
13. GATE, #2
14. SOURCE, #2
15. GATE, #1
16. SOURCE, #1

STYLE 6:
PIN 1. CATHODE
2. CATHODE
3. CATHODE
4. CATHODE
5. CATHODE
6. CATHODE
7. CATHODE
8. CATHODE
9. ANODE
10. ANODE
11. ANODE
12. ANODE
13. ANODE
14. ANODE
15. ANODE
16. ANODE

STYLE 7:
PIN 1. SOURCE N-CH
2. COMMON DRAIN (OUTPUT)
3. COMMON DRAIN (OUTPUT)
4. GATE P-CH
5. COMMON DRAIN (OUTPUT)
6. COMMON DRAIN (OUTPUT)
7. COMMON DRAIN (OUTPUT)
8. SOURCE P-CH
9. SOURCE P-CH
10. COMMON DRAIN (OUTPUT)
11. COMMON DRAIN (OUTPUT)
12. COMMON DRAIN (OUTPUT)
13. GATE N-CH
14. COMMON DRAIN (OUTPUT)
15. COMMON DRAIN (OUTPUT)
16. SOURCE N-CH

SOLDERING FOOTPRINT

8X
6.40

16X 1.12

1   16

16X
0.58

1.27
PITCH

8   9
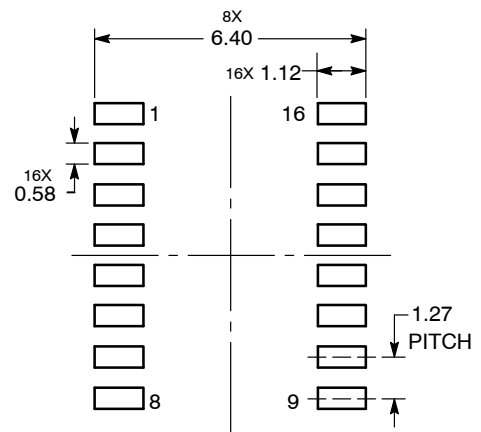
DIMENSIONS: MILLIMETERS

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